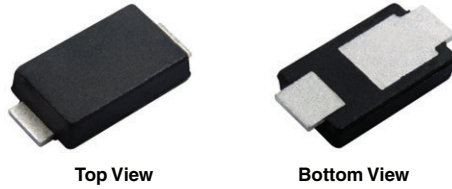


# Surface-Mount TMBS<sup>®</sup> (Trench MOS Barrier Schottky) Rectifier

**eSMP<sup>®</sup> Series**


Top View

Bottom View

**SMPA (DO-221BC)**

Anode Cathode

**LINKS TO ADDITIONAL RESOURCES**

[3D Models](#)

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	8.0 A
$V_{RRM}$	100 V
$I_{FSM}$	90 A
$V_F$ at $I_F = 8.0$ A ( $T_J = 125$ °C)	0.63 V
$T_J$ max.	175 °C
Package	SMPA (DO-221BC)
Circuit configuration	Single

**FEATURES**

- Very low profile - typical height of 0.95 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code: P/NHM3
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
 COMPLIANT  
 HALOGEN  
**FREE**
**TYPICAL APPLICATIONS**

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial and automotive applications.

**MECHANICAL DATA**
**Case:** SMPA (DO-221BC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

**Polarity:** color band denotes cathode end

MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)			
PARAMETER	SYMBOL	V8PAM10S	UNIT
Device marking code		8MBS	
Maximum repetitive peak reverse voltage	$V_{RRM}$	100	V
Maximum DC forward current	$I_{F(AV)}$ <sup>(1)</sup>	8.0	A
	$I_{F(AV)}$ <sup>(2)</sup>	2.8	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	$I_{FSM}$	90	A
Operating junction temperature range	$T_J$ <sup>(3)</sup>	-40 to +175	°C
Storage temperature range	$T_{STG}$	-55 to +175	°C

**Notes**
<sup>(1)</sup> Units mounted on 3 cm x 3 cm aluminum PCB

<sup>(2)</sup> Free air, mounted on recommended copper pad area, 2 oz., FR4 PCB

<sup>(3)</sup> The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$

<b>ELECTRICAL CHARACTERISTICS</b> ( $T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	$I_F = 4.0\text{ A}$	$T_J = 25\text{ }^\circ\text{C}$	$V_F^{(1)}$	0.61	-	V
	$I_F = 8.0\text{ A}$			0.75	0.84	
	$I_F = 4.0\text{ A}$	$T_J = 125\text{ }^\circ\text{C}$		0.53	-	
	$I_F = 8.0\text{ A}$			0.63	0.71	
Reverse current	$V_R = 70\text{ V}$	$T_J = 25\text{ }^\circ\text{C}$	$I_R^{(2)}$	0.003	-	mA
		$T_J = 125\text{ }^\circ\text{C}$		1.5	-	
	$V_R = 100\text{ V}$	$T_J = 25\text{ }^\circ\text{C}$		-	0.18	
		$T_J = 125\text{ }^\circ\text{C}$		3	9	
Typical junction capacitance	4.0 V, 1 MHz		$C_J$	600	-	pF

**Notes**

- (1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle  
 (2) Pulse test: Pulse width  $\leq 5\text{ ms}$

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise specified)			
PARAMETER	SYMBOL	V8PAM10S	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)(2)}$	100	$^\circ\text{C/W}$
	$R_{\theta JM}^{(3)}$	5	

**Notes**

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$   
 (2) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient  
 (3) Units mounted on 3 cm x 3 cm aluminum PCB; thermal resistance  $R_{\theta JM}$  - junction to mount

<b>ORDERING INFORMATION</b> (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V8PAM10S-M3/H	0.032	H	3500	7" diameter plastic tape and reel
V8PAM10S-M3/I	0.032	I	14 000	13" diameter plastic tape and reel
V8PAM10SHM3/H <sup>(1)</sup>	0.032	H	3500	7" diameter plastic tape and reel
V8PAM10SHM3/I <sup>(1)</sup>	0.032	I	14 000	13" diameter plastic tape and reel

**Note**

- (1) AEC-Q101 qualified

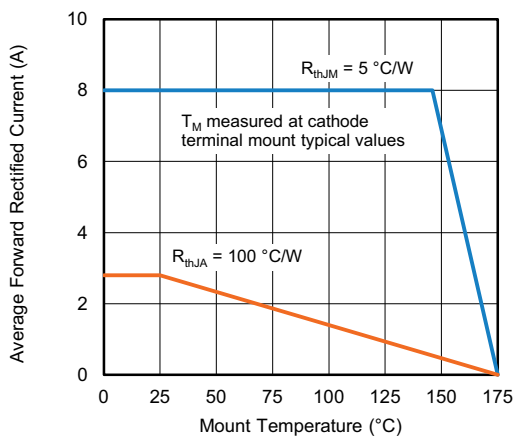
**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise specified)


Fig. 1 - Maximum Forward Current Derating Curve

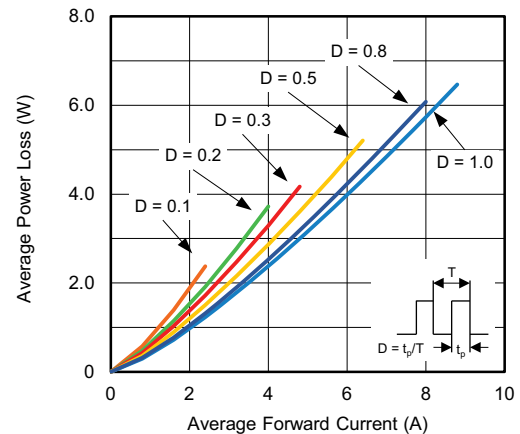


Fig. 2 - Forward Power Loss Characteristics

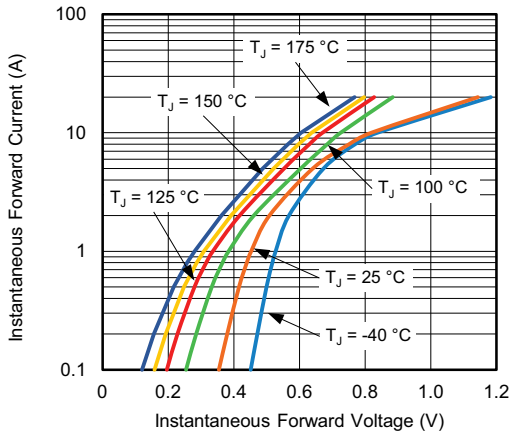


Fig. 3 - Typical Instantaneous Forward Characteristics

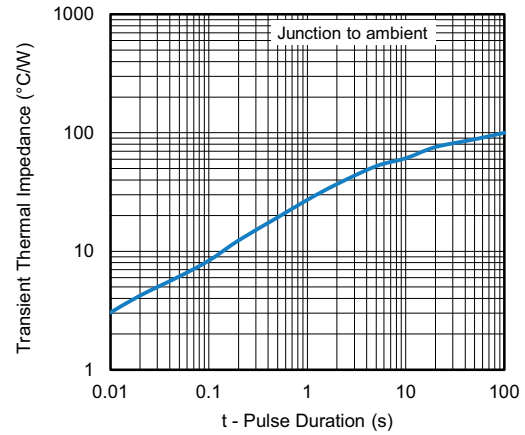


Fig. 6 - Typical Transient Thermal Impedance

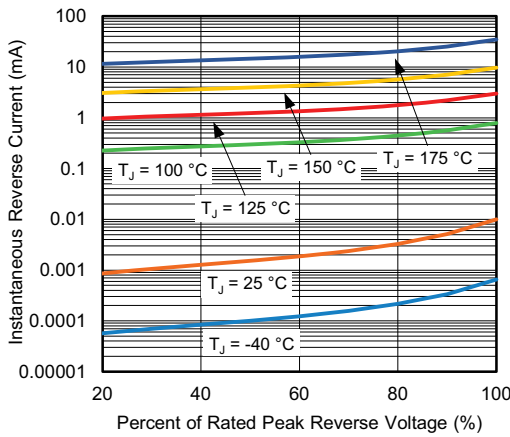


Fig. 4 - Typical Reverse Leakage Characteristics

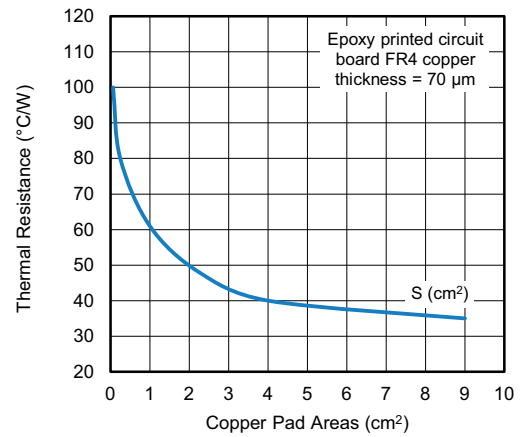


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas

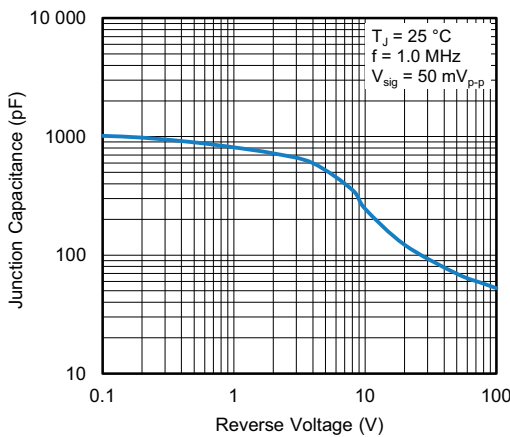
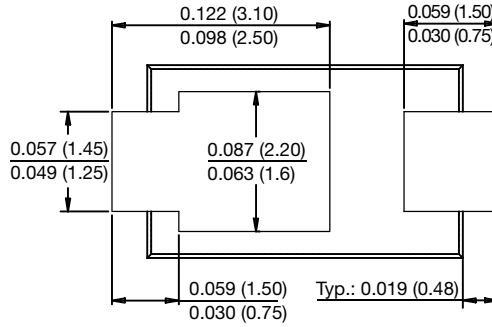
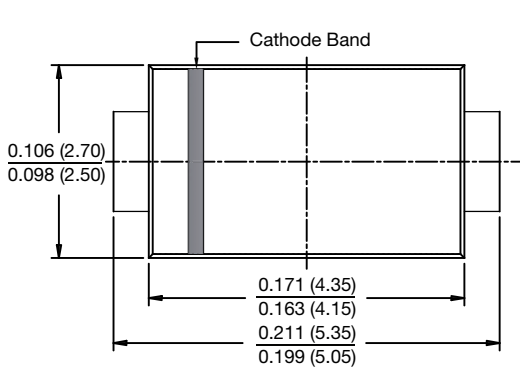


Fig. 5 - Typical Junction Capacitance

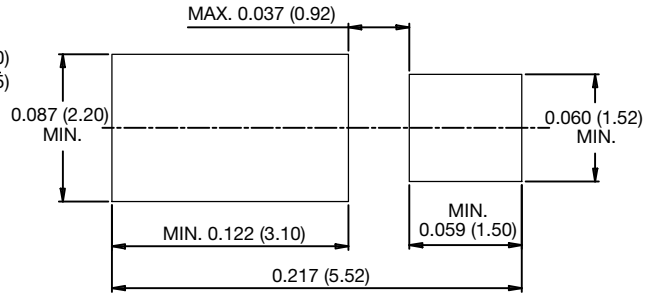
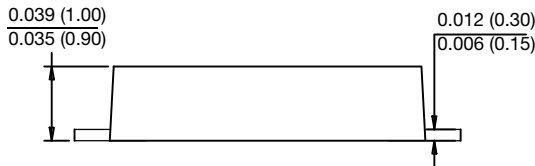


PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMPA (DO-221BC)



Mounting Pad Layout





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